

4-Mbit (512K x 8) Static RAM

Features

- Temperature Ranges
 - Commercial: 0°C to 70°C
 - Industrial: –40°C to 85°C
 - Automotive: –40°C to 125°C
- High speed
- t_{AA} = 10 ns
- Low active power
 - 324 mW (max.)
- 2.0V data retention
- Automatic power-down when deselected
- TTL-compatible inputs and outputs
- Easy memory expansion with CE and OE features

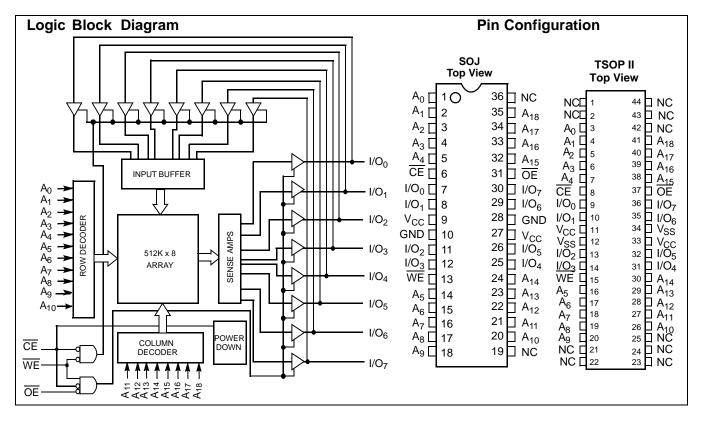
Functional Description^[1]

The CY7C1049CV33 is a high-performance CMOS Static RAM organized as 524,288 words by 8 bits. Easy <u>memory</u> expansion is provided by an active LOW Chip Enable (CE), an active LOW Output Enable (OE), and three-state drivers. <u>Writing to the device is accomplished by taking Chip Enable</u> (CE) and Write Enable (WE) inputs LOW. Data on the eight I/O pins (I/O₀ through I/O₇) is then written into the location specified on the address pins (A₀ through A₁₈).

Reading from the device is accomplished by taking Chip Enable (\overline{OE}) and Output Enable (\overline{OE}) LOW while forcing Write Enable (WE) HIGH. Under these conditions, the contents of the memory location specified by the address pins will appear on the I/O pins.

The eight input/output pins (I/O₀ through I/O₇) are placed in <u>a</u> high-impedance state when the <u>device</u> is deselected (CE HIGH), the <u>outputs</u> are disabled (OE HIGH), or during a Write operation (CE LOW, and WE LOW).

The CY7C1049CV33 is available in standard 400-mil-wide 36-pin SOJ package and 44-pin TSOP II package with center power and ground (revolutionary) pinout.



Notes:

1. For guidelines on SRAM system design, please refer to the 'System Design Guidelines' Cypress application note, available on the internet at www.cypress.com.

Cypress Semiconductor Corporation Document #: 38-05006 Rev. *C



Selection Guide

		-8 []	-10	-12	-15	Unit
Maximum Access Time		8	10	12	15	ns
Maximum Operating Current	Commercial	100	90	85	80	mA
	Industrial	110	100	95	90	mA
	Automotive	-	-	-	95	mA
Maximum CMOS Standby Current	Commercial / Industrial	10	10	10	10	mA
	Automotive	-	-	-	15	mA

Shaded areas contain advance information.

Pin Definitions

Pin Name	36-SOJ Pin Number	44 TSOP-II Pin Number	I/О Туре	Description
A ₀ -A ₁₈	1-5,14-18,	3-7,16-20,	Input	Address Inputs used to select one of the address locations.
	20-24,32-35	26-30,38-41		
1/0 ₀ - 1/0 ₇	7,8,11,12,25,	9,10,13,14,	Input/Output	Bidirectional Data I/O lines. Used as input or output lines
	26,29,30	31,32,35,36		depending on operation
NC ^[2]	19,36	1,2,21,22,23, 24,25,42,43,	No Connect	No Connects. This pin is not connected to the die
		44		
WE	13	15	Input/Control	Write Enable Input, active LOW. When selected LOW, a WRITE is conducted. When selected HIGH, a READ is conducted.
CE	6	8	Input/Control	Chip Enable Input, active LOW. When LOW, selects the chip. When HIGH, deselects the chip.
OE	31	37	Input/Control	Output Enable, active LOW. Controls the direction of the I/O pins. When LOW, the I/O pins are allowed to behave as outputs. When deasserted HIGH, I/O pins are three-stated, and act as input data pins.
V _{SS} , GND	10,28	12,34	Ground	Ground for the device. Should be connected to ground of the system.
V _{CC}	9,27	11,33	Power Supply	Power Supply inputs to the device.

Notes: 2. NC pins are not connected on the die.



Maximum Ratings

(Above which the useful life may be impaired. For user guide-	
lines, not tested.)	

Storage Temperature	–65°C to +150°C
Ambient Temperature	with
Power Applied	–55°C to +125°C

Supply Voltage on V_{CC} to Relative $GND^{[3]}\,....\,-\!0.5V$ to +4.6V

DC Voltage Applied to Outputs
DC Voltage Applied to Outputs in High-Z State ^[3]

in High-Z State ^[3]	–0.5V to V _{CC} + 0.5V
DC Input Voltage ^[3]	0.5V to V _{CC} + 0.5V
Current into Outputs (LOW)	

Operating Range

Range	Ambient Temperature	V _{cc}
Commercial	0°C to +70°C	$3.3V\pm0.3V$
Industrial	-40°C to +85°C	
Automotive	-40°C to +125°C	

Electrical Characteristics Over the Operating Range

Parame-	-			-8 []		-1	0	-12		-15		
ter	Description	Test Cond	Test Conditions		Max.	Min.	Max.	Min.	Max.	Min.	Max.	Unit
V _{OH}	Output HIGH Voltage	$V_{CC} = Min.; I_{OH} = $	–4.0 mA	2.4		2.4		2.4		2.4		V
V _{OL}	Output LOW Voltage	$V_{CC} = Min.,; I_{OL} =$	8.0 mA		0.4		0.4		0.4		0.4	V
V _{IH}	Input HIGH Voltage			2.0	V _{CC} + 0.3	2.0	V _{CC} + 0.3	2.0	V _{CC} + 0.3	2.0	V _{CC} + 0.3	V
V _{IL}	Input LOW Voltage ^[3]			-0.3	0.8	-0.3	0.8	-0.3	0.8	-0.3	0.8	V
I _{IX}	Input Load Current	$GND \leq V_{I} \leq V_{CC}$	Com'l / Ind'l	-1	+1	-1	+1	-1	+1	-1	+1	μA
			Automotive	-	-	-	-	-	-	-20	+20	μΑ
I _{OZ}	Output Leakage Current	$GND \leq V_{OUT} \leq V_{CC}$	Com'l / Ind'l	-1	+1	-1	+1	-1	+1	-1	+1	μA
		Output Disabled	Automotive	-	-	-	-	-	-	-20	+20	μΑ
I _{CC}	V _{CC} Operating	V _{CC} = Max.,	Com'l		100		90		85		80	mA
	Supply Current	$f = f_{MAX} = 1/t_{RC}$	Ind'l		110		100		95		90	mA
			Automotive		-		-		-		95	mA
I _{SB1}	Automatic CE	Max. V _{CC} , <u>CE ≥</u>	Com'l / Ind'l		40		40		40		40	mA
	Power-down Current —TTL Inputs	V_{IH} ; $V_{IN} \ge V_{IH}$ or $V_{IN} \le V_{IL}$, $f = f_{MAX}$	Automotive		-		-		-		45	mA
I _{SB2}	Automatic CE	<u>Ma</u> x. V _{CC} ,	Com'l/Ind'l		10		10		10		10	mA
	Power-down Current —CMOS Inputs	$\begin{array}{l} CE \geq V_{CC} - 0.3V, \\ V_{IN} \geq V_{CC} - 0.3V, \\ or \ V_{IN} \leq 0.3V, \\ f = 0 \end{array}$			-		-		-		15	mA

Capacitance^[4]

Parameter	Description	Test Conditions	Max.	Unit
C _{IN}	Input Capacitance	$T_A = 25^{\circ}C, f = 1 \text{ MHz},$	8	pF
C _{OUT}	I/O Capacitance	$V_{\rm CC} = 3.3 V$	8	pF

Thermal Resistance^[4]

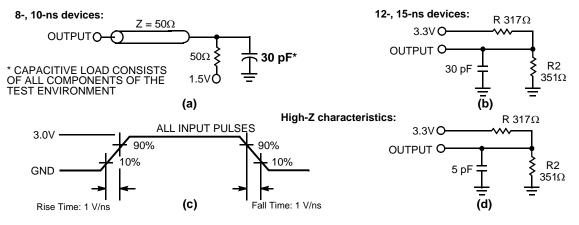
Parameter	Description	Test Conditions	36-pin SOJ (Non Pb-Free)	36-pin SOJ (Pb-Free)	44-TSOP-II (Non Pb-Free)	44-TSOP-II (Pb-Free)	Unit
Θ_{JA}	(Junction to Ambient)	Test conditions follow standard test methods and procedures for	46.51	46.51	41.66	41.66	°C/W
Θ_{JC}		measuring thermal impedance, per EIA / JESD51.	18.8	18.8	10.56	10.56	°C/W

Notes:

3. V_{IL} (min.) = -2.0V and V_{IH} (max) = V_{CC} + 0.5V for pulse durations of less than 20 ns. 4. Tested initially and after any design or process changes that may affect these parameters.



AC Test Loads and Waveforms^[5]



AC Switching Characteristics^[6] Over the Operating Range

		-:	8 []	-	10	-′	12	-'	15	
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	Unit
Read Cycle										
t _{power} [7]	V _{CC} (typical) to the first access	1		1		1		1		μS
t _{RC}	Read Cycle Time	8		10		12		15		ns
t _{AA}	Address to Data Valid		8		10		12		15	ns
t _{OHA}	Data Hold from Address Change	3		3		3			3	ns
t _{ACE}	CE LOW to Data Valid		8		10		12		15	ns
t _{DOE}	OE LOW to Data Valid		4		5		6		7	ns
t _{LZOE}	OE LOW to Low-Z	0		0		0		0		ns
t _{HZOE}	OE HIGH to High-Z ^[8, 9]		4		5		6		7	ns
t _{LZCE}	CE LOW to Low-Z ^[9]	3		3		3		3		ns
t _{HZCE}	CE HIGH to High-Z ^[8, 9]		4		5		6		7	ns
t _{PU}	CE LOW to Power-up	0		0		0		0		ns
t _{PD}	CE HIGH to Power-down		8		10		12		15	ns
Write Cycle [[]	10, 11]					1		1		
t _{WC}	Write Cycle Time	8		10		12		15		ns
t _{SCE}	CE LOW to Write End	6		7		8		10		ns
t _{AW}	Address Set-up to Write End	6		7		8		10		ns
t _{HA}	Address Hold from Write End	0		0		0		0		ns
t _{SA}	Address Set-up to Write Start	0		0		0		0		ns
t _{PWE}	WE Pulse Width	6		7		8		10		ns
t _{SD}	Data Set-up to Write End	4		5		6		7		ns
t _{HD}	Data Hold from Write End	0		0		0		0		ns
t _{LZWE}	WE HIGH to Low-Z ^[9]	3		3		3		3		ns
t _{HZWE}	WE LOW to High-Z ^[8, 9]		4		5		6		7	ns

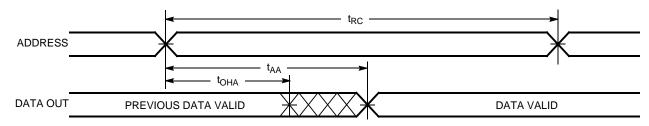
Notes:

5. AC characteristics (except High-Z) for all 8-ns and 10-ns parts are tested using the load conditions shown in Figure (a). All other speeds are tested using the Thevenin load shown in Figure (b). High-Z characteristics are tested for all speeds using the test load shown in Figure (d).

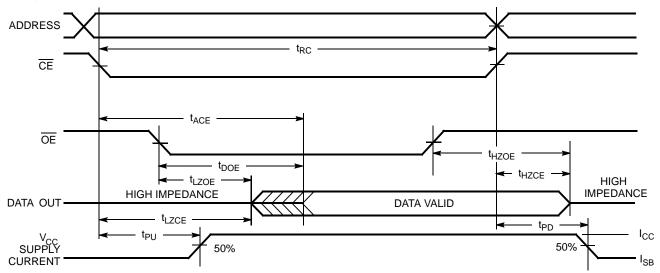


Switching Waveforms

Read Cycle No. 1^[12, 13]



Read Cycle No. 2 (OE Controlled)^[13, 14]



Notes:

- 6. Test conditions assume signal transition time of 3 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V.

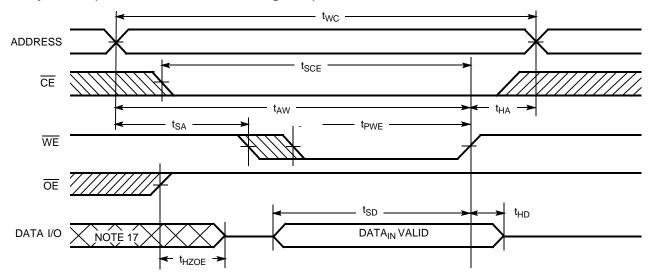
- b. Test conditions assume signal transition time of 3 ns or less, timing reference levels of 1.5V, input pulse levels of 0 to 3.0V.
 7. t_{POWER} gives the minimum amount of time that the power supply should be at stable, typical V_{CC} values until the first memory access can be performed.
 8. t_{HZOE}, t_{HZCE}, and t_{HZWE} are specified with a load capacitance of 5 pF as in part (d) of AC Test Loads. Transition is measured ±500 mV from steady-state voltage.
 9. At any given temperature and voltage condition, t_{HZCE} is less than t_{LZCE}, t_{HZOE}, and t_{HZWE} is less than t_{LZWE} for any given device.
 10. The internal Write time of the memory is defined by the overlap of CE LOW, and WE LOW. CE and WE must be LOW to initiate a Write, and the transition of either of these signals can terminate the Write. The input data set-up and hold timing should be referenced to the leading edge of the signal that terminates the Write.
 11. The minimum Write cycle time for Write Cycle No. 3 (WE controlled, OE LOW) is the sum of t_{HZWE} and t_{SD}.
- 12. Device is continuously selected. \overline{OE} , $\overline{CE} = V_{IL}$.

13. WE is HIGH for Read cycle.

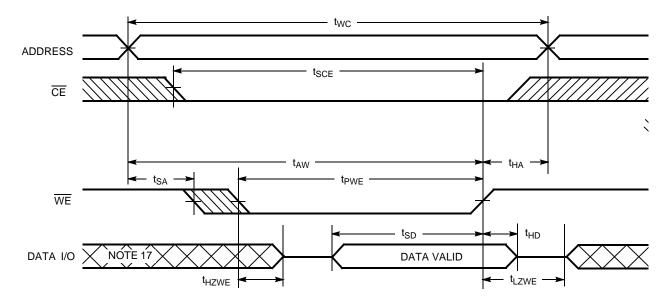


Switching Waveforms (continued)

Write Cycle No. 1(WE Controlled, OE HIGH During Write)^[15, 16]



Write Cycle No. 2 (\overline{WE} Controlled, \overline{OE} LOW)^[16]



Notes:

14. Address valid prior to or coincident with \overline{CE} transition LOW.

15. Data I/O is high-impedance if $\overline{OE} = V_{IH}$. 16. If \overline{CE} goes HIGH simultaneously with \overline{WE} going HIGH, the output remains in a high-impedance state.

17. During this period the I/Os are in the output state and input signals should not be applied.



Truth Table

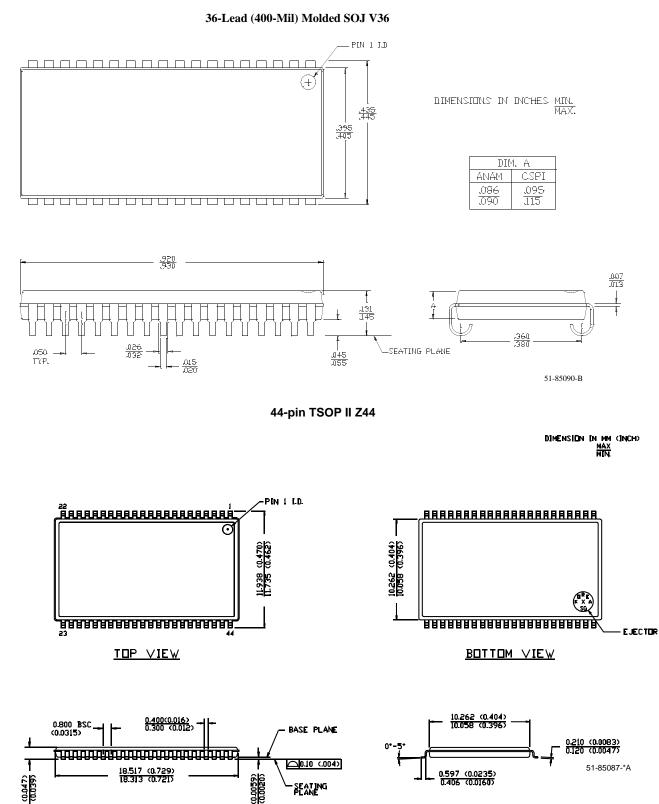
CE	OE	WE	I/O ₀ –I/O ₇	Mode	Power
Н	Х	Х	High-Z	Power-down	Standby (I _{SB})
L	L	Н	Data Out	Read	Active (I _{CC})
L	Х	L	Data In	Write	Active (I _{CC})
L	Н	Н	High-Z	Selected, Outputs Disabled	Active (I _{CC})

Ordering Information

Speed (ns)	Ordering Code	Package Name	Package Type	Operating Range	
10	CY7C1049CV33-10VC	V36	36-lead (400-Mil) Molded SOJ	Commercial	
	CY7C1049CV33-10ZC	Z44	44-pin TSOP II		
	CY7C1049CV33-10VI	V36	36-lead (400-Mil) Molded SOJ	Industrial	
	CY7C1049CV33-10ZI	Z44	44-pin TSOP II		
12	CY7C1049CV33-12VC	V36	36-lead (400-Mil) Molded SOJ	Commercial	
	CY7C1049CV33-12ZC	Z44	44-pin TSOP II		
	CY7C1049CV33-12VI	V36	36-lead (400-Mil) Molded SOJ	Industrial	
	CY7C1049CV33-12ZI	Z44	44-pin TSOP II		
15	CY7C1049CV33-15VXC	V36	36-lead (400-Mil) Molded SOJ (Pb-Free)	Commercial	
	CY7C1049CV33-15VC	V36	36-lead (400-Mil) Molded SOJ		
	CY7C1049CV33-15ZXC	Z44	44-pin TSOP II (Pb-Free)		
	CY7C1049CV33-15ZC	Z44	44-pin TSOP II		
	CY7C1049CV33-15VI	V36	36-lead (400-Mil) Molded SOJ	Industrial	
	CY7C1049CV33-15ZI	Z44	44-pin TSOP II		
	CY7C1049CV33-15VE	V36	36-lead (400-Mil) Molded SOJ	Automotive	
	CY7C1049CV33-15ZE	Z44	44-pin TSOP II		



Package Diagrams



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Document History Page

	Document Title: CY7C1049CV33 4-Mbit (512K x 8) Static RAM Document Number: 38-05006						
REV.	ECN NO.	Issue Date	Orig. of Change	Description of Change			
**	112569	03/06/02	HGK	New Data Sheet			
*A	114091	04/25/02	DFP	Changed Tpower unit from ns to μ s			
*B	116479	09/16/02	CEA	Add applications foot note to data sheet, page 1.			
*C	262949	See ECN	RKF	Added Automotive Specs to Datasheet Added Θ_{JA} and Θ_{JC} values on Page #3.			